909室御QSKQSH供的商DISCRETE/OPTO)

99D 16668

T-39-13

TOSHIBA FIELD EFFECT TRANSISTOR

2 S K 3 8 8

SILICON N CHANNEL MOS TYPE $(\pi-Mos)$

SEMICONDUCTOR SEMICONDUCTOR

TECHNICAL DATA

HIGH SPEED, HIGH VOLTAGE SWITCHING APPLICATIONS. SWITCHING REGULATOR, DC-DC CONVERTER AND MOTOR DRIVE APPLICATIONS.

FEATURES:

- . Low Drain-Source ON Resistance : $R_{DS\,(ON)}$ =0.2 Ω (Typ.)
- . High Forward Transfer Admittance : $|Y_{fs}| = 6S$ (Typ.)
- . Low Leakage Current : I_{GSS} = ± 100 nA(Max.) @ V_{GS} = ± 20 V

IDSS=1mA(Max.) @ VDS=250V

. Enhancement-Mode : $V_{th}=1.5 \sim 3.5V$ @ $I_D=1mA$

MAXIMUM RATINGS (Ta=25°C)

CHARACTERISTIC		SYMBOL	RATING	UNIT	
Drain-Source Voltage		V _{DSX}	250	V	
Gate-Source Voltage		V _{GSS}	±20	V	
Drain Current	DC	ID	12	А	
Didin odriene	Pulse	IDP	30		
Drain Power Dissipation (Tc=25°C)		PD	150	W	
Channel Temperature		Tch	150	°C	
Storage Temperature Range		Tstg	-55~150	°c	

INDUSTRIAL APPLICATIONS

1. GATE

2. DRAIN (HEAT SINK) 3. SOURCE

JEDEC EIAJ TOSHIBA 2-21F1B

Weight: 9.7g

ELECTRICAL CHARACTERISTICS (Ta=25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakage Current		IGSS	V _{GS} =±20V, V _{DS} =0	-	-	±100	nΑ
Drain Cut-off Current		IDSS	V _{DS} =250V, V _{GS} =0	_	-	1.0	mA
Drain-Source Breakdown Voltage		V(BR)DSS	$I_D=10mA$, $V_{GS}=0$	250	-	-	V
Gate Threshold Voltage		Vth	V _{DS} =10V, I _D =1mA	1.5	-	3.5	V
Forward Transfer Admittance		lYfsl	V _{DS} =10V, I _D =10A	3	6	-	S
Drain-Source ON Resistance		R _{DS} (ON)	I _D =10A, V _{GS} =10V	-	0.20	0.25	Ω
Drain-Source ON Voltage		VDS(ON)	I _D =10A, V _{GS} =10V	-	2.0	2.5	v
Input Capacitance		Ciss	V _{DS} =10V, V _{GS} =0, f=1MHz	-	1600	2000	pF
Reverse Transfer Capacitance		Crss	V _{DS} =10V, V _{GS} =0, f=1MHz	-	220	320	pF
Output Capacitance		Coss	V _{DS} =10V, V _{GS} =0, f=1MHz	-	570	700	pF
Switching Time	Rise Time	tra	10V VIN C VOUT 10 VIN C N N N N N N N N N N N N N N N N N N	-	110	220	ns
	Turn-on Time	ton		-	130	260	ns
	Fall Time	tf	α 1 + 1	1	100	200	ns
	Turn-off Time	toff	$v_{IN}: t_r, t_r < 5 \text{ ns} v_{DD} \stackrel{?}{+} 200 \text{ V}$ $v_{IN}: t_r, t_r < 5 \text{ ns} v_{DD} \stackrel{?}{+} 200 \text{ V}$		320	640	ns

TOSHIBA CORPORATION

GTIA2

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909室都QSK (980H共政商 DISCRETE/OPTO)

99D 16669

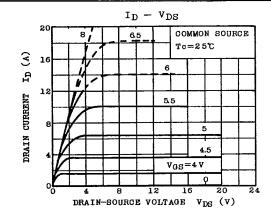
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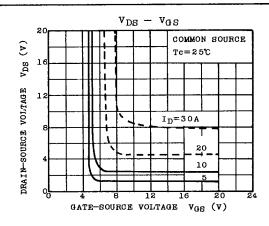


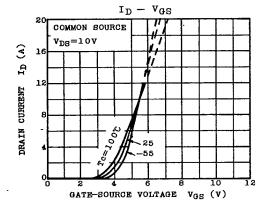
SEMICONDUCTOR

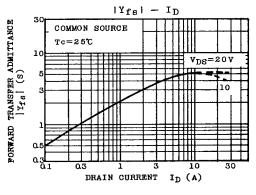
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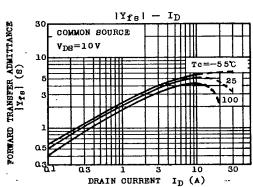
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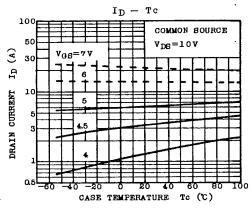












TOSHIBA CORPORATION

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900名 (DISCRETE / OPTO)

99D 16670

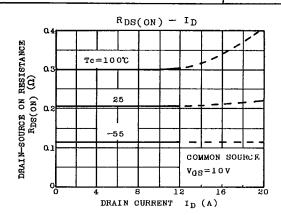
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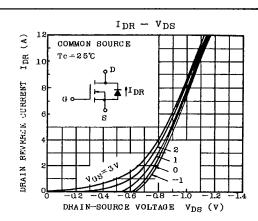


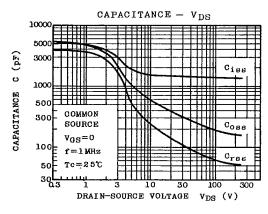
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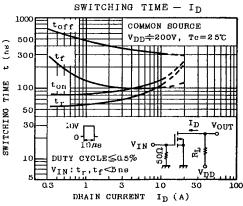
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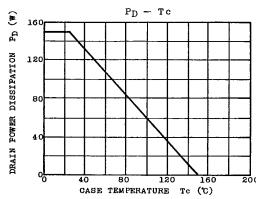
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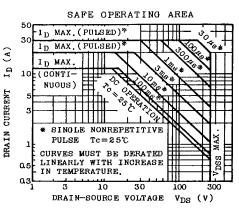












TOSHIBA CORPORATION

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